

Title (en)
DEVICE FOR CONTROLLING THE TEMPERATURE OF MICROCOMPONENTS

Title (de)
EINRICHTUNG ZUM TEMPERIEREN VON MIKROKOMPONENTEN

Title (fr)
DISPOSITIF POUR EQUILIBRER LA TEMPERATURE DE MICROCOMPOSANTS

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Abstract (en)
[origin: WO0243853A1] The invention relates to a device for controlling the temperature of microcomponents, (2) especially microreactors, which are preferably embodied in a plate-like manner and preferably consist of silicon. At least one microcomponent is pressed against a temperature-controlling element (15, 20) in a holding device. A flat, heat conducting connection is provided between the microcomponent (2) and the temperature-controlling element (15, 20).

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